FIG.1

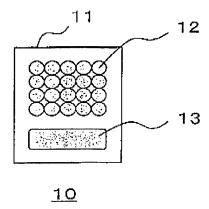


FIG.2

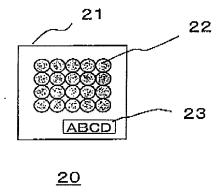


FIG.3

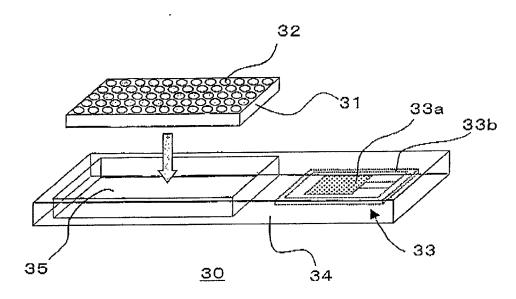


FIG.4

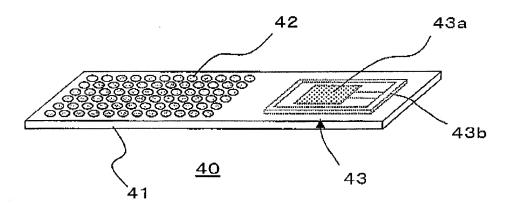


FIG.5

	. —		,	,		· · · · ·		
	t number	preparation	ote (n)	Additional chip information	Additional spotting information (1)	(2)	***************************************	(F)
					Spotting condition information (1)	(2)		(u)
					Spot No. (1) Spotting location [coordinates (x1,y1)] Spotting condition information (1) Additional spotting information (1)	[coordinates (x2,y2)]		[coordinates (xn,yn)]
Chip number	Fabrication lot number	Date/time of preparation	Number of spots (n)	Additional chi	Spot No. (1)	(2)		(u)

FIG.6

62
61

65

66

67

67

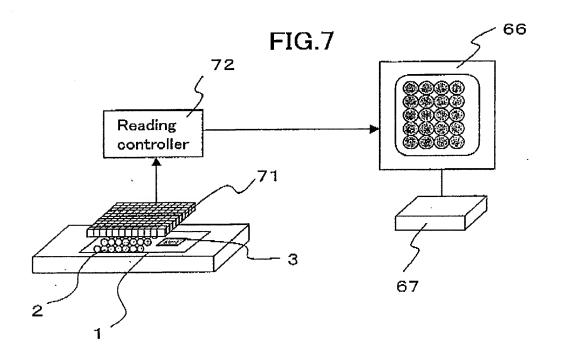
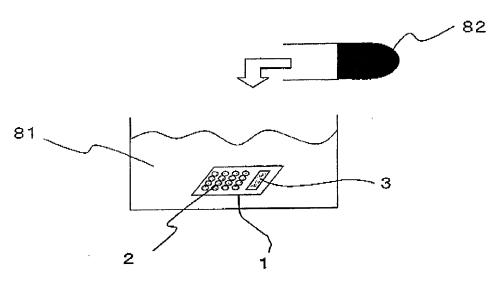


FIG.8



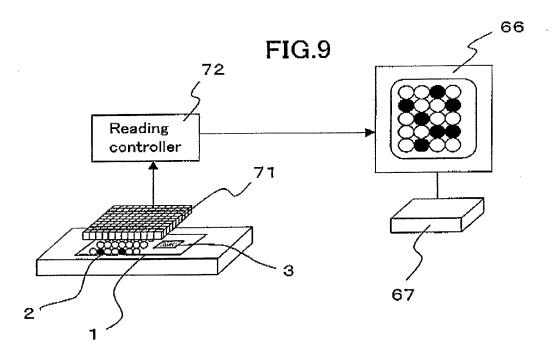


FIG.10

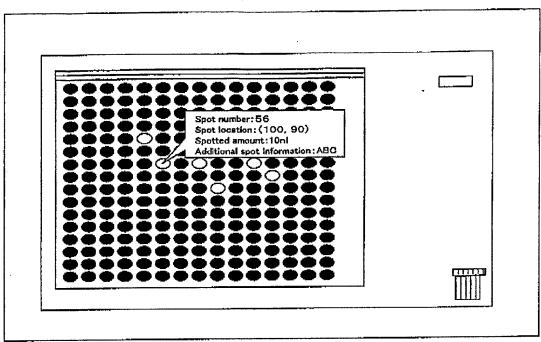


FIG.11

